

Product / Process Change Notification



N° 2017-079-A

Dear Customer,

Please find attached our INFINEON Technologies PCN:

Introduction of Infineon`s 12 inch Wafer Fab Locations in Villach, Austria and Dresden, Germany in addition to Infineon`s 8 inch Wafer Fab Location in Villach, Austria

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **05. March 2018**.
- Infineon aligns with the widely-recognized JEDEC STANDARD “**JESD46**“, which stipulates:
“**Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.**”

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG
Postal Address Headquarters: Am Campeon 1-15, D-85579 Neubiberg, Phone +49 (0)89 234-0
Chairman of the Supervisory Board: Wolfgang Mayrhuber
Management Board: Dr. Reinhard Ploss (CEO), Dominik Asam, Dr. Helmut Gassel, Jochen Hanebeck
Registered Office: Neubiberg Commercial Register
Amtsgericht München HRB 126492

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► Products affected:

Sales Name	SP N°	OPN	Package
FS450R07A2P2_B31	SP001351336	FS450R07A2P2B31BOSA1	AG-HYBRID2-1-1
FS820R08A6P2	SP001499702	FS820R08A6P2BPSA1	AG-HYBRIDD-1-1
FS820R08A6P2B	SP001499708	FS820R08A6P2BBPSA1	AG-HYBRIDD-1-1
FS820R08A6P2LB	SP001611366	FS820R08A6P2LBBPSA1	AG-HYBRIDD-1-1
FS820R08A6P2LM	SP001700462	FS820R08A6P2LMBPSA1	AG-HYBRIDD-1-1
FS900R08A2P2_B31	SP001232072	FS900R08A2P2B31BOSA1	AG-HYBRID2-1-1
FS900R08A2P2_B32	SP001709602	FS900R08A2P2B32BOSA1	AG-HYBRID2-1-1

► Detailed Change Information:

Subject: Introduction of Infineon`s 12 inch wafer fab locations in Villach, Austria and Dresden, Germany in addition to Infineon`s 8 inch wafer fab location in Villach, Austria.

Reason: Capacity increase and to ensure secure supply.

Description:

	<u>Old</u>	<u>New</u>
Wafer fab location:	<ul style="list-style-type: none"> ■ Infineon Villach, Austria 	<ul style="list-style-type: none"> ■ Infineon Villach, Austria <i>or</i> ■ Infineon Dresden Germany
Wafer diameter:	<ul style="list-style-type: none"> ■ 200mm 	<ul style="list-style-type: none"> ■ 200mm (Infineon Villach) <i>or</i> ■ 300mm (Infineon Villach) <i>or</i> ■ 300mm (Infineon Dresden)
Wafer test location:	<ul style="list-style-type: none"> ■ Infineon Villach, Austria 	<ul style="list-style-type: none"> ■ Infineon Villach, Austria <i>or</i> Infineon Dresden, Germany

► Product Identification:

Traceability is ensured by lotnumber.

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► **Impact of Change:** No change in fit, form or function of the final product. No impact on reliability and processability expected based on the qualification performed.

► **Attachments:** None

► **Time Schedule:**

- Final qualification report: Available on request
- First samples available: Available on demand
- Intended start of delivery: January 2018 or upon customer's PCN approval

If you have any questions, please do not hesitate to contact your local Sales office.